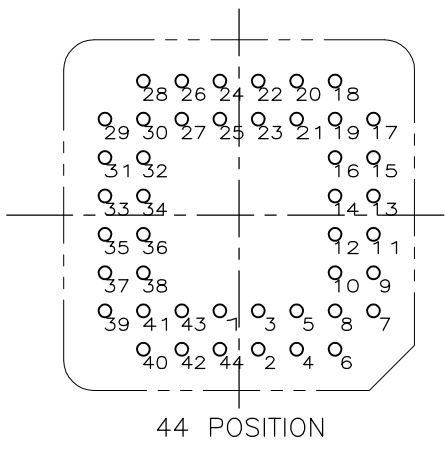
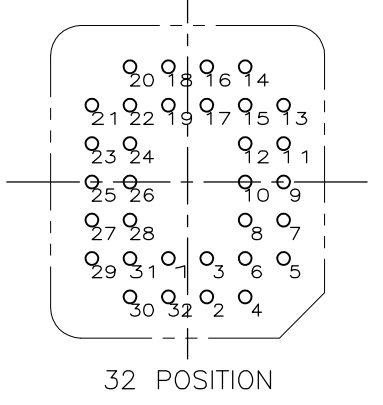
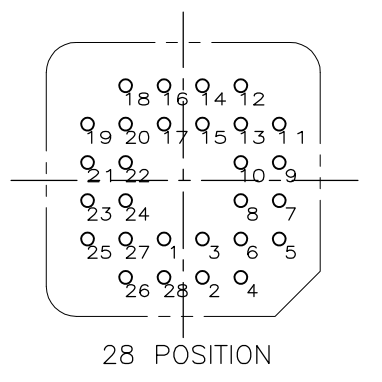
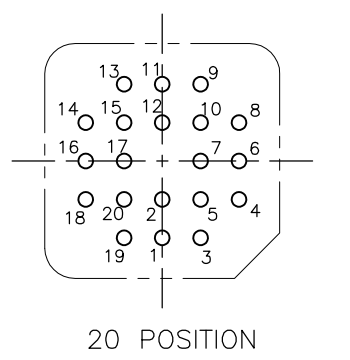
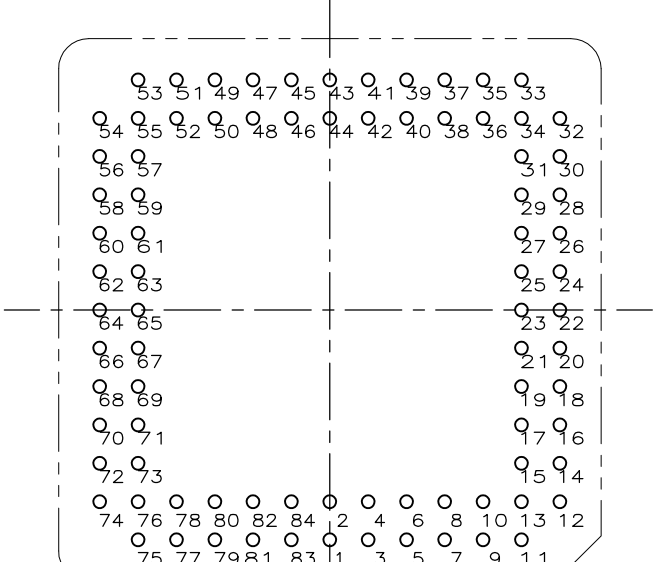
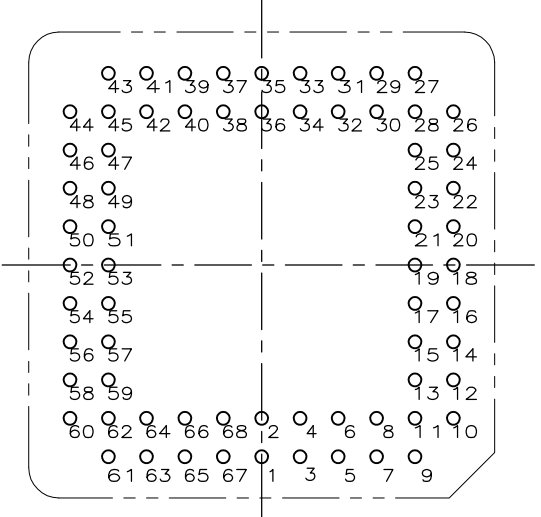
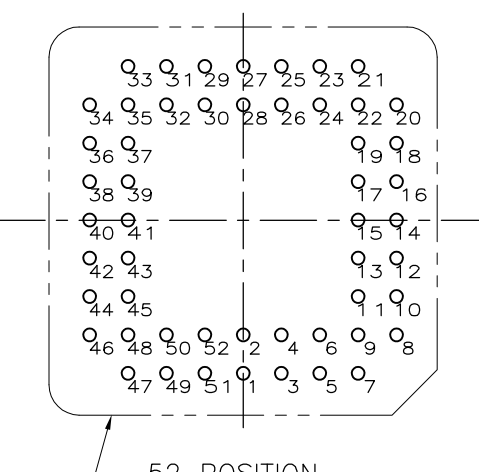
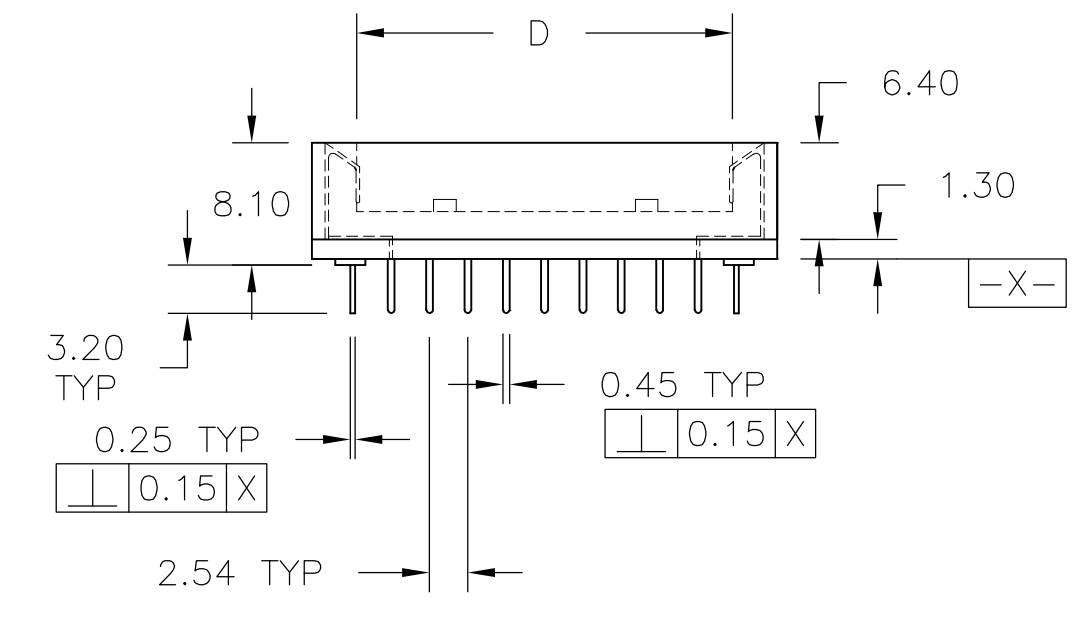


RECOMMENDED PCB FOOT PRINT



RECOMMENDED CIRCUIT CONFIGURATION VIEWED FROM COMPONENT SIDE OF CIRCUIT

- △ MATERIAL:
HOUSING - THERMOPLASTIC UL94 V-0.
CONTACT - PHOSPHOR BRONZE.
- △ FINISH: CONTACT PLATING: 1.52μm 90/10 TIN-LEAD OVER 0.51μm NICKEL ALL OVER.
- 3. PLASTIC LEADED CHIP CARRIER MUST CONFORM TO JEDEC SPECS. MS-016 & MS-018.
- 4. SPECIFICATION SUBJECT TO CHANGE WITHOUT NOTICE. CONTACT AMP FOR THE LATEST SPECIFICATIONS.
- △ FINISH: CONTACT PLATING 2.03μm TIN OVER 0.76μm NICKEL, ALL OVER.
- △ RDHS 2002/95/EC COMPLIANT

PERFORMANCE INFORMATION		
TEST DESCRIPTION	REQUIREMENT	TEST SPECIFICATION
TERMINATION RESISTANCE	20 MILLIOHMS MAX INITIAL, 40 MILLIOHMS MAX FINAL AFTER VIBRATION, HUMIDITY AND THERMAL SHOCK.	MIL-STD-1344A METHOD 3004.1
INSULATION RESISTANCE	1,000 MEGADHMS MIN INITIAL, 500 MEGADHMS MIN AFTER HUMIDITY AND THERMAL SHOCK.	MIL-STD-1344A METHOD 3003.1
DIELECTRIC WITHSTANDING VOLTAGE	600V RMS BETWEEN ADJACENT CONTACTS, 1 MINUTE HOLD. NO EVIDENCE OF BREAKDOWN OR FLASHOVER AFTER HUMIDITY AND THERMAL SHOCK.	MIL-STD-1344A METHOD 3001.1
VIBRATION	10-55-10 HZ PER MINUTE, 1.52mm AMPLITUDE, 2 HOURS IN EACH DIRECTION. NO DISCONTINUITIES OR LOOSENING OF PARTS. MUST PASS TERMINATION RESISTANCE.	MIL-STD-1344A CONDITION B METHOD 2005.1
DURABILITY	30 CYCLES NO VISIBLE DEFECTS, CONTACT RESISTANCE 20 MILLIOHMS MAX.	MIL-STD-1344A METHOD 2016
MATING FORCE	425 GRAMS (15 OZ) MAX PER CONTACT. INSERT AT CONSTANT SPEED OF 25mm PER MINUTE.	-
UNMATING FORCE	10 GRAMS (.35 OZ) MIN PER CONTACT. WITHDRAW AT CONSTANT SPEED OF 25mm PER MINUTE.	-
THERMAL SHOCK	25 CYCLES 1 CYCLE = -25°C FOR 30 MINUTES AND +105°C FOR 30 MINUTES. MUST PASS INSULATION RESISTANCE, DIELECTRIC WITHSTANDING AND TERMINATION RESISTANCE.	MIL-STD-202F CONDITION B METHOD 107E
CONTACT RETENTION FORCE	250 GRAMS (8.8 OZ) MIN PER CONTACT. CONTACT PULLED AT CONSTANT SPEED OF 25mm PER MINUTE.	-
HUMIDITY	48 HOURS AT 90-95% RELATIVE HUMIDITY AT 40±2°C. MUST PASS INSULATION RESISTANCE, DIELECTRIC WITHSTANDING AND TERMINATION RESISTANCE.	MIL-STD-1344A TYPE 1, CONDITION B METHOD 1002.2
SOLDERABILITY	95% MINIMUM COVERAGE. IMMERSE FOR 5±5 SECONDS IN 230±5°C BATH.	MIL-STD-202F METHOD 208
RESISTANCE TO SOLDERING HEAT	IMMERSE FOR 5±5 SECONDS IN 260±5°C BATH. SPECIMEN MOUNTED ON PC BOARD. NO DEFORMATION ALLOWED.	-
CURRENT RATING	1 AMP	-
VOLTAGE RATING	250V	-
TEMPERATURE RATING	-55°C TO +170°C	-

△	△	29.42	29.42	46.15	25.40	25.40	35.88	35.88	1248	TUBE	84	1-822473-7
△	△	24.38	24.38	39.00	20.32	20.32	30.80	30.80	1596	TUBE	68	1-822473-6
△	△	19.30	19.30	31.50	15.24	15.24	25.72	25.72	2254	TUBE	52	1-822473-5
△	△	16.74	16.74	27.50	12.70	12.70	23.18	23.18	2800	TUBE	44	1-822473-4
△	△	13.94	11.36	22.65	10.16	7.62	20.54	18.10	4060	TUBE	32	1-822473-3
△	△	11.46	11.46	20.70	7.62	7.62	18.10	18.10	4620	TUBE	28	1-822473-2
△	△	8.90	8.90	17.20	5.08	5.08	15.56	15.56	6552	TUBE	20	1-822473-1
△	△	29.42	29.42	46.15	25.40	25.40	35.88	35.88	1248	TUBE	84	822473-7
△	△	24.38	24.38	39.00	20.32	20.32	30.80	30.80	1596	TUBE	68	822473-6
△	△	19.30	19.30	31.50	15.24	15.24	25.72	25.72	2254	TUBE	52	822473-5
△	△	16.74	16.74	27.50	12.70	12.70	23.18	23.18	2800	TUBE	44	822473-4
△	△	13.94	11.36	22.65	10.16	7.62	20.54	18.10	4060	TUBE	32	822473-3
△	△	11.46	11.46	20.70	7.62	7.62	18.10	18.10	4620	TUBE	28	822473-2
△	△	8.90	8.90	17.20	5.08	5.08	15.56	15.56	6552	TUBE	20	822473-1

FINISH	E	D	C	B2	B1	A2	A1	TOTAL QUANTITY PER CARTON	PACKAGING	NO. OF POSITIONS	AMP PART NUMBER
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THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS: MM	TOLERANCES UNLESS OTHERWISE SPECIFIED:	DMN A.HOLT 26AUG99	CHK B.KUHNLY 25MAR99
0 PLG ±	1 PLG ±	DRP B.KUHNLY 20MAR99	NAME B.KUHNLY
2 PLG ± 0.20	3 PLG ±	SIZE	DATE
4 PLG ±	ANGLES ±	DRAWING NO	REV

MATERIAL: △ FINISH: △ △

WEIGHT: A1 00779 ©=822473

CUSTOMER DRAWING

OBSELETE NOT the LATEST REVISION